Special Issue

New Trends and Future Challenges in Computational Microwave Imaging

Message from the Guest Editors

This Special Issue is aimed at highlighting the challenges, current trends, and most recent advances in computational microwave imaging as applied to several non-invasive *EM* problems. Keywords:

- Computational microwave imaging
- Inverse scattering
- Biomedical imaging
- Subsurface imaging
- Through-the-wall imaging
- Non-destructive testing/evaluation
- Structural health monitoring

Please click here to find information! Welcome to contribute!

Guest Editors

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Deadline for manuscript submissions

closed (31 March 2021)



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Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guest-edited by leading experts in selected topics of interest.

Editor-in-Chief

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